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### Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Active
Number of LABs/CLBs	7911
Number of Logic Elements/Cells	101261
Total RAM Bits	4939776
Number of I/O	498
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	900-BBGA
Supplier Device Package	900-FBGA (31x31)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xc6slx100t-3fg900i">https://www.e-xfl.com/product-detail/xilinx/xc6slx100t-3fg900i</a>

Table 5: Typical Quiescent Supply Current (Cont'd)

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
I <sub>CCAUXQ</sub>	Quiescent V <sub>CCAUX</sub> supply current	LX4	2.5	2.5	2.5	2.5	mA
		LX9	2.5	2.5	2.5	2.5	mA
		LX16	3.0	3.0	3.0	3.0	mA
		LX25	4.0	4.0	4.0	4.0	mA
		LX25T	4.0	4.0	4.0	N/A	mA
		LX45	5.0	5.0	5.0	5.0	mA
		LX45T	5.0	5.0	5.0	N/A	mA
		LX75	7.0	7.0	7.0	7.0	mA
		LX75T	7.0	7.0	7.0	N/A	mA
		LX100	9.0	9.0	9.0	9.0	mA
		LX100T	9.0	9.0	9.0	N/A	mA
		LX150	12.0	12.0	12.0	12.0	mA
		LX150T	12.0	12.0	12.0	N/A	mA

**Notes:**

1. Typical values are specified at nominal voltage, 25°C junction temperatures (T<sub>j</sub>). Industrial (I) grade devices have the same typical values as commercial (C) grade devices at 25°C, but higher values at 100°C. Use the XPE tool to calculate 100°C values. Nominal V<sub>CCINT</sub> is 1.20V; use the XPE tool to calculate 1.23V values for the nominal V<sub>CCINT</sub> of the extended performance range.
2. Typical values are for blank configured devices with no output current loads, no active input pull-up resistors, all I/O pins are 3-state and floating.
3. If differential signaling is used, more accurate quiescent current estimates can be obtained by using the XPOWER Estimator (XPE) or XPOWER Analyzer (XPA) tools.

Table 6: Power Supply Ramp Time

Symbol	Description	Speed Grade	Ramp Time	Units
V <sub>CCINTR</sub>	Internal supply voltage ramp time	-3, -3N, -2	0.20 to 50.0	ms
		-1L	0.20 to 40.0	ms
V <sub>CCO2</sub> <sup>(1)</sup>	Output drivers bank 2 supply voltage ramp time	All	0.20 to 50.0	ms
V <sub>CCAUXR</sub>	Auxiliary supply voltage ramp time	All	0.20 to 50.0	ms

**Notes:**

1. The minimum V<sub>CCO2</sub> for power-on reset and configuration is 1.65V.
2. Spartan-6 FPGAs require a certain amount of supply current during power-on to insure proper device initialization. The actual current consumed depends on the power-on ramp rate of the power supply. Use the XPOWER Estimator (XPE) or XPOWER Analyzer (XPA) tools to estimate current drain on these supplies. Spartan-6 devices do not have a required power-on sequence.

## GTP Transceiver DC Input and Output Levels

Table 16 summarizes the DC output specifications of the GTP transceivers in Spartan-6 FPGAs. Figure 1 shows the single-ended output voltage swing. Figure 2 shows the peak-to-peak differential output voltage.

Consult UG386: *Spartan-6 FPGA GTP Transceivers User Guide* for further details.

Table 16: GTP Transceiver DC Specifications

Symbol	DC Parameter	Conditions	Min	Typ	Max	Units
DV <sub>PPIN</sub>	Differential peak-to-peak input voltage	External AC coupled	140	–	2000	mV
V <sub>IN</sub>	Absolute input voltage	DC coupled MGTAVTTRX = 1.2V	–400	–	MGTAVTTRX	mV
V <sub>CMIN</sub>	Common mode input voltage	DC coupled MGTAVTTRX = 1.2V	–	3/4 MGTAVTTRX	–	mV
DV <sub>PPOUT</sub>	Differential peak-to-peak output voltage <sup>(1)</sup>	Transmitter output swing is set to maximum setting	–	–	1000	mV
V <sub>SEOUT</sub>	Single-ended output voltage swing <sup>(1)</sup>		–	–	500	mV
V <sub>CMOUTDC</sub>	Common mode output voltage	Equation based	MGTAVTTTX – V <sub>SEOUT</sub> /2			mV
R <sub>IN</sub>	Differential input resistance		80	100	130	Ω
R <sub>OUT</sub>	Differential output resistance		80	100	130	Ω
T <sub>OSKEW</sub>	Transmitter output skew		–	–	15	ps
C <sub>EXT</sub>	Recommended external AC coupling capacitor <sup>(2)</sup>		75	100	200	nF

**Notes:**

1. The output swing and preemphasis levels are programmable using the attributes discussed in UG386: *Spartan-6 FPGA GTP Transceivers User Guide* and can result in values lower than reported in this table.
2. Other values can be used as appropriate to conform to specific protocols and standards.

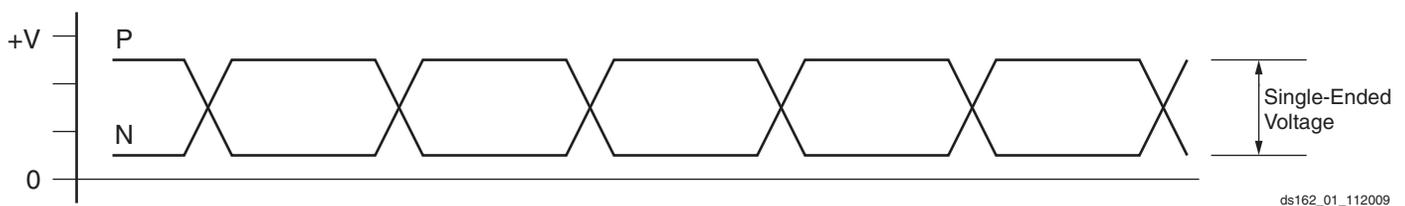


Figure 1: Single-Ended Peak-to-Peak Voltage

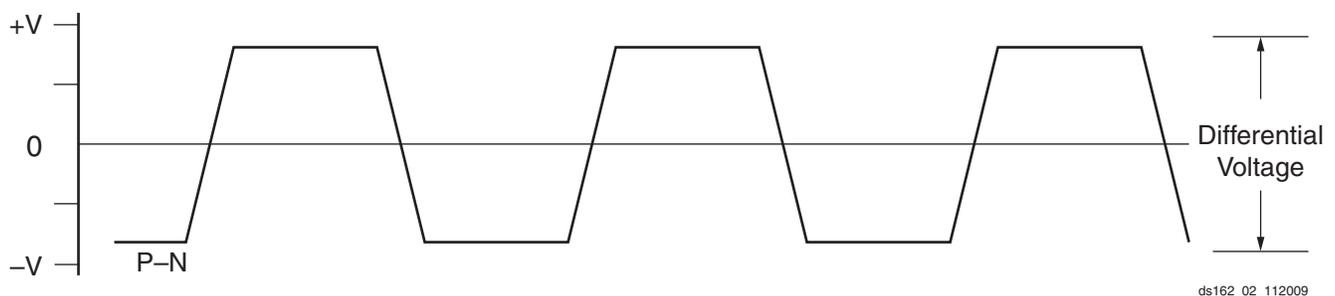


Figure 2: Differential Peak-to-Peak Voltage

Table 17 summarizes the DC specifications of the clock input of the GTP transceiver. Consult UG386: *Spartan-6 FPGA GTP Transceivers User Guide* for further details.

## Switching Characteristics

All values represented in this data sheet are based on these speed specifications: v1.20 for -3, -3N, and -2; and v1.08 for -1L. Switching characteristics are specified on a per-speed-grade basis and can be designated as Advance, Preliminary, or Production. Each designation is defined as follows:

### Advance

These specifications are based on simulations only and are typically available soon after device design specifications are frozen. Although speed grades with this designation are considered relatively stable and conservative, some under-reporting might still occur.

### Preliminary

These specifications are based on complete ES (engineering sample) silicon characterization. Devices and speed grades with this designation are intended to give a better indication of the expected performance of production silicon. The probability of under-reporting delays is greatly reduced as compared to Advance data.

### Production

These specifications are released once enough production silicon of a particular device family member has been characterized to provide full correlation between specifications and devices over numerous production lots. There is no under-reporting of delays, and customers receive formal notification of any subsequent changes. Typically, the slowest speed grades transition to Production before faster speed grades.

All specifications are always representative of worst-case supply voltage and junction temperature conditions.

Since individual family members are produced at different times, the migration from one category to another depends completely on the status of the fabrication process for each device.

The -1L speed grade refers to the lower-power Spartan-6 devices. The -3N speed grade refers to the Spartan-6 devices that do not support MCB functionality.

[Table 26](#) correlates the current status of each Spartan-6 device on a per speed grade basis.

## Testing of Switching Characteristics

All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values.

For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer and back-annotate to the simulation net list. Unless otherwise noted, values apply to all Spartan-6 devices.

Table 26: Spartan-6 Device Speed Grade Designations

Device	Speed Grade Designations		
	Advance	Preliminary	Production
XC6SLX4 <sup>(1)</sup>			-3, -2, -1L
XC6SLX9			-3, -3N, -2, -1L
XC6SLX16			-3, -3N, -2, -1L
XC6SLX25			-3, -3N, -2, -1L
XC6SLX25T			-3, -3N, -2
XC6SLX45			-3, -3N, -2, -1L
XC6SLX45T			-3, -3N, -2
XC6SLX75			-3, -3N, -2, -1L
XC6SLX75T			-3, -3N, -2
XC6SLX100			-3, -3N, -2, -1L
XC6SLX100T			-3, -3N, -2
XC6SLX150			-3, -3N, -2, -1L
XC6SLX150T			-3, -3N, -2
XA6SLX4			-3, -2
XA6SLX9			-3, -2
XA6SLX16			-3, -2
XA6SLX25			-3, -2
XA6SLX25T			-3, -2
XA6SLX45			-3, -2
XA6SLX45T			-3, -2
XA6SLX75			-3, -2
XA6SLX75T			-3, -2
XA6SLX100			-2
XQ6SLX75			-2, -1L
XQ6SLX75T			-3, -2
XQ6SLX150			-2, -1L
XQ6SLX150T			-3, -2

### Notes:

1. The XC6SLX4 is not available in the -3N speed grade.

**Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)**

I/O Standard	T <sub>IOPI</sub>				T <sub>IOOP</sub>				T <sub>IOTP</sub>				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	
LVC MOS33, Fast, 8 mA	1.34	1.46	1.59	1.82	2.07	2.21	2.41	3.03	2.07	2.21	2.41	3.03	ns
LVC MOS33, Fast, 12 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns
LVC MOS33, Fast, 16 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns
LVC MOS33, Fast, 24 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns
LVC MOS25, QUIETIO, 2 mA	0.82	0.94	1.07	1.31	4.81	4.95	5.15	5.79	4.81	4.95	5.15	5.79	ns
LVC MOS25, QUIETIO, 4 mA	0.82	0.94	1.07	1.31	3.70	3.84	4.04	4.66	3.70	3.84	4.04	4.66	ns
LVC MOS25, QUIETIO, 6 mA	0.82	0.94	1.07	1.31	3.46	3.60	3.80	4.38	3.46	3.60	3.80	4.38	ns
LVC MOS25, QUIETIO, 8 mA	0.82	0.94	1.07	1.31	3.20	3.34	3.54	4.12	3.20	3.34	3.54	4.12	ns
LVC MOS25, QUIETIO, 12 mA	0.82	0.94	1.07	1.31	2.83	2.97	3.17	3.75	2.83	2.97	3.17	3.75	ns
LVC MOS25, QUIETIO, 16 mA	0.82	0.94	1.07	1.31	2.64	2.78	2.98	3.64	2.64	2.78	2.98	3.64	ns
LVC MOS25, QUIETIO, 24 mA	0.82	0.94	1.07	1.31	2.45	2.59	2.79	3.42	2.45	2.59	2.79	3.42	ns
LVC MOS25, Slow, 2 mA	0.82	0.94	1.07	1.31	3.78	3.92	4.12	4.76	3.78	3.92	4.12	4.76	ns
LVC MOS25, Slow, 4 mA	0.82	0.94	1.07	1.31	2.79	2.93	3.13	3.73	2.79	2.93	3.13	3.73	ns
LVC MOS25, Slow, 6 mA	0.82	0.94	1.07	1.31	2.73	2.87	3.07	3.66	2.73	2.87	3.07	3.66	ns
LVC MOS25, Slow, 8 mA	0.82	0.94	1.07	1.31	2.48	2.62	2.82	3.42	2.48	2.62	2.82	3.42	ns
LVC MOS25, Slow, 12 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.95	2.01	2.15	2.35	2.95	ns
LVC MOS25, Slow, 16 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.95	2.01	2.15	2.35	2.95	ns
LVC MOS25, Slow, 24 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.94	2.01	2.15	2.35	2.94	ns
LVC MOS25, Fast, 2 mA	0.82	0.94	1.07	1.31	3.35	3.49	3.69	4.31	3.35	3.49	3.69	4.31	ns
LVC MOS25, Fast, 4 mA	0.82	0.94	1.07	1.31	2.25	2.39	2.59	3.22	2.25	2.39	2.59	3.22	ns
LVC MOS25, Fast, 6 mA	0.82	0.94	1.07	1.31	2.09	2.23	2.43	3.05	2.09	2.23	2.43	3.05	ns
LVC MOS25, Fast, 8 mA	0.82	0.94	1.07	1.31	2.02	2.16	2.36	2.98	2.02	2.16	2.36	2.98	ns
LVC MOS25, Fast, 12 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns
LVC MOS25, Fast, 16 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns
LVC MOS25, Fast, 24 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns
LVC MOS18, QUIETIO, 2 mA	1.18	1.30	1.43	2.04	5.92	6.06	6.26	6.80	5.92	6.06	6.26	6.80	ns
LVC MOS18, QUIETIO, 4 mA	1.18	1.30	1.43	2.04	4.74	4.88	5.08	5.63	4.74	4.88	5.08	5.63	ns
LVC MOS18, QUIETIO, 6 mA	1.18	1.30	1.43	2.04	4.05	4.19	4.39	4.96	4.05	4.19	4.39	4.96	ns
LVC MOS18, QUIETIO, 8 mA	1.18	1.30	1.43	2.04	3.71	3.85	4.05	4.63	3.71	3.85	4.05	4.63	ns
LVC MOS18, QUIETIO, 12 mA	1.18	1.30	1.43	2.04	3.35	3.49	3.69	4.27	3.35	3.49	3.69	4.27	ns
LVC MOS18, QUIETIO, 16 mA	1.18	1.30	1.43	2.04	3.20	3.34	3.54	4.14	3.20	3.34	3.54	4.14	ns
LVC MOS18, QUIETIO, 24 mA	1.18	1.30	1.43	2.04	2.96	3.10	3.30	3.98	2.96	3.10	3.30	3.98	ns
LVC MOS18, Slow, 2 mA	1.18	1.30	1.43	2.04	4.62	4.76	4.96	5.54	4.62	4.76	4.96	5.54	ns
LVC MOS18, Slow, 4 mA	1.18	1.30	1.43	2.04	3.69	3.83	4.03	4.60	3.69	3.83	4.03	4.60	ns
LVC MOS18, Slow, 6 mA	1.18	1.30	1.43	2.04	3.00	3.14	3.34	3.94	3.00	3.14	3.34	3.94	ns
LVC MOS18, Slow, 8 mA	1.18	1.30	1.43	2.04	2.19	2.33	2.53	3.17	2.19	2.33	2.53	3.17	ns
LVC MOS18, Slow, 12 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18, Slow, 16 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T <sub>IOPI</sub>				T <sub>IOOP</sub>				T <sub>IOTP</sub>				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	
LVC MOS18, Slow, 24 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18, Fast, 2 mA	1.18	1.30	1.43	2.04	3.59	3.73	3.93	4.53	3.59	3.73	3.93	4.53	ns
LVC MOS18, Fast, 4 mA	1.18	1.30	1.43	2.04	2.39	2.53	2.73	3.35	2.39	2.53	2.73	3.35	ns
LVC MOS18, Fast, 6 mA	1.18	1.30	1.43	2.04	1.88	2.02	2.22	2.84	1.88	2.02	2.22	2.84	ns
LVC MOS18, Fast, 8 mA	1.18	1.30	1.43	2.04	1.81	1.95	2.15	2.77	1.81	1.95	2.15	2.77	ns
LVC MOS18, Fast, 12 mA	1.18	1.30	1.43	2.04	1.71	1.85	2.05	2.67	1.71	1.85	2.05	2.67	ns
LVC MOS18, Fast, 16 mA	1.18	1.30	1.43	2.04	1.71	1.85	2.05	2.67	1.71	1.85	2.05	2.67	ns
LVC MOS18, Fast, 24 mA	1.18	1.30	1.43	2.04	1.71	1.85	2.05	2.67	1.71	1.85	2.05	2.67	ns
LVC MOS18_JEDEC, QUIETIO, 2 mA	0.94	1.06	1.19	1.41	5.91	6.05	6.25	6.79	5.91	6.05	6.25	6.79	ns
LVC MOS18_JEDEC, QUIETIO, 4 mA	0.94	1.06	1.19	1.41	4.75	4.89	5.09	5.64	4.75	4.89	5.09	5.64	ns
LVC MOS18_JEDEC, QUIETIO, 6 mA	0.94	1.06	1.19	1.41	4.04	4.18	4.38	4.96	4.04	4.18	4.38	4.96	ns
LVC MOS18_JEDEC, QUIETIO, 8 mA	0.94	1.06	1.19	1.41	3.71	3.85	4.05	4.62	3.71	3.85	4.05	4.62	ns
LVC MOS18_JEDEC, QUIETIO, 12 mA	0.94	1.06	1.19	1.41	3.35	3.49	3.69	4.28	3.35	3.49	3.69	4.28	ns
LVC MOS18_JEDEC, QUIETIO, 16 mA	0.94	1.06	1.19	1.41	3.20	3.34	3.54	4.13	3.20	3.34	3.54	4.13	ns
LVC MOS18_JEDEC, QUIETIO, 24 mA	0.94	1.06	1.19	1.41	2.96	3.10	3.30	3.98	2.96	3.10	3.30	3.98	ns
LVC MOS18_JEDEC, Slow, 2 mA	0.94	1.06	1.19	1.41	4.59	4.73	4.93	5.54	4.59	4.73	4.93	5.54	ns
LVC MOS18_JEDEC, Slow, 4 mA	0.94	1.06	1.19	1.41	3.69	3.83	4.03	4.60	3.69	3.83	4.03	4.60	ns
LVC MOS18_JEDEC, Slow, 6 mA	0.94	1.06	1.19	1.41	3.00	3.14	3.34	3.94	3.00	3.14	3.34	3.94	ns
LVC MOS18_JEDEC, Slow, 8 mA	0.94	1.06	1.19	1.41	2.19	2.33	2.53	3.18	2.19	2.33	2.53	3.18	ns
LVC MOS18_JEDEC, Slow, 12 mA	0.94	1.06	1.19	1.41	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18_JEDEC, Slow, 16 mA	0.94	1.06	1.19	1.41	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18_JEDEC, Slow, 24 mA	0.94	1.06	1.19	1.41	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18_JEDEC, Fast, 2 mA	0.94	1.06	1.19	1.41	3.57	3.71	3.91	4.52	3.57	3.71	3.91	4.52	ns
LVC MOS18_JEDEC, Fast, 4 mA	0.94	1.06	1.19	1.41	2.39	2.53	2.73	3.35	2.39	2.53	2.73	3.35	ns
LVC MOS18_JEDEC, Fast, 6 mA	0.94	1.06	1.19	1.41	1.88	2.02	2.22	2.84	1.88	2.02	2.22	2.84	ns
LVC MOS18_JEDEC, Fast, 8 mA	0.94	1.06	1.19	1.41	1.80	1.94	2.14	2.76	1.80	1.94	2.14	2.76	ns
LVC MOS18_JEDEC, Fast, 12 mA	0.94	1.06	1.19	1.41	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
LVC MOS18_JEDEC, Fast, 16 mA	0.94	1.06	1.19	1.41	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
LVC MOS18_JEDEC, Fast, 24 mA	0.94	1.06	1.19	1.41	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
LVC MOS15, QUIETIO, 2 mA	0.98	1.10	1.23	1.79	5.47	5.61	5.81	6.38	5.47	5.61	5.81	6.38	ns
LVC MOS15, QUIETIO, 4 mA	0.98	1.10	1.23	1.79	4.61	4.75	4.95	5.51	4.61	4.75	4.95	5.51	ns
LVC MOS15, QUIETIO, 6 mA	0.98	1.10	1.23	1.79	4.07	4.21	4.41	4.97	4.07	4.21	4.41	4.97	ns
LVC MOS15, QUIETIO, 8 mA	0.98	1.10	1.23	1.79	3.91	4.05	4.25	4.81	3.91	4.05	4.25	4.81	ns
LVC MOS15, QUIETIO, 12 mA	0.98	1.10	1.23	1.79	3.53	3.67	3.87	4.51	3.53	3.67	3.87	4.51	ns
LVC MOS15, QUIETIO, 16 mA	0.98	1.10	1.23	1.79	3.32	3.46	3.66	4.31	3.32	3.46	3.66	4.31	ns
LVC MOS15, Slow, 2 mA	0.98	1.10	1.23	1.79	4.18	4.32	4.52	5.11	4.18	4.32	4.52	5.11	ns
LVC MOS15, Slow, 4 mA	0.98	1.10	1.23	1.79	3.42	3.56	3.76	4.34	3.42	3.56	3.76	4.34	ns
LVC MOS15, Slow, 6 mA	0.98	1.10	1.23	1.79	2.29	2.43	2.63	3.24	2.29	2.43	2.63	3.24	ns

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T <sub>IOPI</sub>				T <sub>IOOP</sub>				T <sub>IOTP</sub>				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	
LVC MOS15, Slow, 8 mA	0.98	1.10	1.23	1.79	2.30	2.44	2.64	3.25	2.30	2.44	2.64	3.25	ns
LVC MOS15, Slow, 12 mA	0.98	1.10	1.23	1.79	2.03	2.17	2.37	2.99	2.03	2.17	2.37	2.99	ns
LVC MOS15, Slow, 16 mA	0.98	1.10	1.23	1.79	2.01	2.15	2.35	2.97	2.01	2.15	2.35	2.97	ns
LVC MOS15, Fast, 2 mA	0.98	1.10	1.23	1.79	3.29	3.43	3.63	4.24	3.29	3.43	3.63	4.24	ns
LVC MOS15, Fast, 4 mA	0.98	1.10	1.23	1.79	2.27	2.41	2.61	3.22	2.27	2.41	2.61	3.22	ns
LVC MOS15, Fast, 6 mA	0.98	1.10	1.23	1.79	1.78	1.92	2.12	2.74	1.78	1.92	2.12	2.74	ns
LVC MOS15, Fast, 8 mA	0.98	1.10	1.23	1.79	1.73	1.87	2.07	2.69	1.73	1.87	2.07	2.69	ns
LVC MOS15, Fast, 12 mA	0.98	1.10	1.23	1.79	1.73	1.87	2.07	2.64	1.73	1.87	2.07	2.64	ns
LVC MOS15, Fast, 16 mA	0.98	1.10	1.23	1.79	1.73	1.87	2.07	2.64	1.73	1.87	2.07	2.64	ns
LVC MOS15_JEDEC, QUIETIO, 2 mA	1.03	1.15	1.28	1.49	5.49	5.63	5.83	6.37	5.49	5.63	5.83	6.37	ns
LVC MOS15_JEDEC, QUIETIO, 4 mA	1.03	1.15	1.28	1.49	4.61	4.75	4.95	5.51	4.61	4.75	4.95	5.51	ns
LVC MOS15_JEDEC, QUIETIO, 6 mA	1.03	1.15	1.28	1.49	4.07	4.21	4.41	4.97	4.07	4.21	4.41	4.97	ns
LVC MOS15_JEDEC, QUIETIO, 8 mA	1.03	1.15	1.28	1.49	3.92	4.06	4.26	4.81	3.92	4.06	4.26	4.81	ns
LVC MOS15_JEDEC, QUIETIO, 12 mA	1.03	1.15	1.28	1.49	3.54	3.68	3.88	4.51	3.54	3.68	3.88	4.51	ns
LVC MOS15_JEDEC, QUIETIO, 16 mA	1.03	1.15	1.28	1.49	3.33	3.47	3.67	4.31	3.33	3.47	3.67	4.31	ns
LVC MOS15_JEDEC, Slow, 2 mA	1.03	1.15	1.28	1.49	4.18	4.32	4.52	5.13	4.18	4.32	4.52	5.13	ns
LVC MOS15_JEDEC, Slow, 4 mA	1.03	1.15	1.28	1.49	3.42	3.56	3.76	4.35	3.42	3.56	3.76	4.35	ns
LVC MOS15_JEDEC, Slow, 6 mA	1.03	1.15	1.28	1.49	2.29	2.43	2.63	3.25	2.29	2.43	2.63	3.25	ns
LVC MOS15_JEDEC, Slow, 8 mA	1.03	1.15	1.28	1.49	2.30	2.44	2.64	3.26	2.30	2.44	2.64	3.26	ns
LVC MOS15_JEDEC, Slow, 12 mA	1.03	1.15	1.28	1.49	2.01	2.15	2.35	2.97	2.01	2.15	2.35	2.97	ns
LVC MOS15_JEDEC, Slow, 16 mA	1.03	1.15	1.28	1.49	2.01	2.15	2.35	2.97	2.01	2.15	2.35	2.97	ns
LVC MOS15_JEDEC, Fast, 2 mA	1.03	1.15	1.28	1.49	3.28	3.42	3.62	4.22	3.28	3.42	3.62	4.22	ns
LVC MOS15_JEDEC, Fast, 4 mA	1.03	1.15	1.28	1.49	2.27	2.41	2.61	3.23	2.27	2.41	2.61	3.23	ns
LVC MOS15_JEDEC, Fast, 6 mA	1.03	1.15	1.28	1.49	1.78	1.92	2.12	2.74	1.78	1.92	2.12	2.74	ns
LVC MOS15_JEDEC, Fast, 8 mA	1.03	1.15	1.28	1.49	1.73	1.87	2.07	2.69	1.73	1.87	2.07	2.69	ns
LVC MOS15_JEDEC, Fast, 12 mA	1.03	1.15	1.28	1.49	1.73	1.87	2.07	2.63	1.73	1.87	2.07	2.63	ns
LVC MOS15_JEDEC, Fast, 16 mA	1.03	1.15	1.28	1.49	1.73	1.87	2.07	2.63	1.73	1.87	2.07	2.63	ns
LVC MOS12, QUIETIO, 2 mA	0.91	1.03	1.16	1.51	6.40	6.54	6.74	7.30	6.40	6.54	6.74	7.30	ns
LVC MOS12, QUIETIO, 4 mA	0.91	1.03	1.16	1.51	4.98	5.12	5.32	5.90	4.98	5.12	5.32	5.90	ns
LVC MOS12, QUIETIO, 6 mA	0.91	1.03	1.16	1.51	4.65	4.79	4.99	5.55	4.65	4.79	4.99	5.55	ns
LVC MOS12, QUIETIO, 8 mA	0.91	1.03	1.16	1.51	4.23	4.37	4.57	5.21	4.23	4.37	4.57	5.21	ns
LVC MOS12, QUIETIO, 12 mA	0.91	1.03	1.16	1.51	3.98	4.12	4.32	4.94	3.98	4.12	4.32	4.94	ns
LVC MOS12, Slow, 2 mA	0.91	1.03	1.16	1.51	4.98	5.12	5.32	5.91	4.98	5.12	5.32	5.91	ns
LVC MOS12, Slow, 4 mA	0.91	1.03	1.16	1.51	2.84	2.98	3.18	3.81	2.84	2.98	3.18	3.81	ns
LVC MOS12, Slow, 6 mA	0.91	1.03	1.16	1.51	2.77	2.91	3.11	3.72	2.77	2.91	3.11	3.72	ns
LVC MOS12, Slow, 8 mA	0.91	1.03	1.16	1.51	2.34	2.48	2.68	3.31	2.34	2.48	2.68	3.31	ns
LVC MOS12, Slow, 12 mA	0.91	1.03	1.16	1.51	2.08	2.22	2.42	3.06	2.08	2.22	2.42	3.06	ns

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices<sup>(1)</sup> (Cont'd)

I/O Standard	T <sub>IOPI</sub>		T <sub>IOOP</sub>		T <sub>IOTP</sub>		Units
	Speed Grade		Speed Grade		Speed Grade		
	-3	-2	-3	-2	-3	-2	
DIFF_SSTL3_I	1.26	1.44	1.95	2.15	1.95	2.15	ns
DIFF_SSTL3_II	1.26	1.44	1.94	2.14	1.94	2.14	ns
DIFF_SSTL2_I	1.09	1.27	1.94	2.14	1.94	2.14	ns
DIFF_SSTL2_II	1.09	1.27	1.90	2.10	1.90	2.10	ns
DIFF_SSTL18_I	1.04	1.22	1.86	2.06	1.86	2.06	ns
DIFF_SSTL18_II	1.05	1.23	1.82	2.02	1.82	2.02	ns
DIFF_SSTL15_II	1.01	1.19	1.81	2.01	1.81	2.01	ns
DIFF_MOBILE_DDR	1.04	1.22	1.89	2.09	1.89	2.09	ns
LVTTL, QUIETIO, 2 mA	1.42	1.60	5.64	5.84	5.64	5.84	ns
LVTTL, QUIETIO, 4 mA	1.42	1.60	4.46	4.66	4.46	4.66	ns
LVTTL, QUIETIO, 6 mA	1.42	1.60	3.92	4.12	3.92	4.12	ns
LVTTL, QUIETIO, 8 mA	1.42	1.60	3.37	3.57	3.37	3.57	ns
LVTTL, QUIETIO, 12 mA	1.42	1.60	3.42	3.62	3.42	3.62	ns
LVTTL, QUIETIO, 16 mA	1.42	1.60	3.09	3.29	3.09	3.29	ns
LVTTL, QUIETIO, 24 mA	1.42	1.60	2.83	3.03	2.83	3.03	ns
LVTTL, Slow, 2 mA	1.42	1.60	4.58	4.78	4.58	4.78	ns
LVTTL, Slow, 4 mA	1.42	1.60	3.38	3.58	3.38	3.58	ns
LVTTL, Slow, 6 mA	1.42	1.60	2.95	3.15	2.95	3.15	ns
LVTTL, Slow, 8 mA	1.42	1.60	2.73	2.93	2.73	2.93	ns
LVTTL, Slow, 12 mA	1.42	1.60	2.72	2.92	2.72	2.92	ns
LVTTL, Slow, 16 mA	1.42	1.60	2.53	2.73	2.53	2.73	ns
LVTTL, Slow, 24 mA	1.42	1.60	2.42	2.62	2.42	2.62	ns
LVTTL, Fast, 2 mA	1.42	1.60	4.04	4.24	4.04	4.24	ns
LVTTL, Fast, 4 mA	1.42	1.60	2.66	2.86	2.66	2.86	ns
LVTTL, Fast, 6 mA	1.42	1.60	2.58	2.78	2.58	2.78	ns
LVTTL, Fast, 8 mA	1.42	1.60	2.46	2.66	2.46	2.66	ns
LVTTL, Fast, 12 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVTTL, Fast, 16 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVTTL, Fast, 24 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVC MOS33, QUIETIO, 2 mA	1.41	1.59	5.65	5.85	5.65	5.85	ns
LVC MOS33, QUIETIO, 4 mA	1.41	1.59	4.20	4.40	4.20	4.40	ns
LVC MOS33, QUIETIO, 6 mA	1.41	1.59	3.65	3.85	3.65	3.85	ns
LVC MOS33, QUIETIO, 8 mA	1.41	1.59	3.51	3.71	3.51	3.71	ns
LVC MOS33, QUIETIO, 12 mA	1.41	1.59	3.09	3.29	3.09	3.29	ns
LVC MOS33, QUIETIO, 16 mA	1.41	1.59	2.91	3.11	2.91	3.11	ns
LVC MOS33, QUIETIO, 24 mA	1.41	1.59	2.73	2.93	2.73	2.93	ns
LVC MOS33, Slow, 2 mA	1.41	1.59	4.59	4.79	4.59	4.79	ns
LVC MOS33, Slow, 4 mA	1.41	1.59	3.14	3.34	3.14	3.34	ns

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices<sup>(1)</sup> (Cont'd)

I/O Standard	T <sub>IOPI</sub>		T <sub>IOOP</sub>		T <sub>IOTP</sub>		Units
	Speed Grade		Speed Grade		Speed Grade		
	-3	-2	-3	-2	-3	-2	
LVC MOS18, QUIETIO, 16 mA	1.25	1.43	3.34	3.54	3.34	3.54	ns
LVC MOS18, QUIETIO, 24 mA	1.25	1.43	3.18	3.38	3.18	3.38	ns
LVC MOS18, Slow, 2 mA	1.25	1.43	4.79	4.99	4.79	4.99	ns
LVC MOS18, Slow, 4 mA	1.25	1.43	3.84	4.04	3.84	4.04	ns
LVC MOS18, Slow, 6 mA	1.25	1.43	3.17	3.37	3.17	3.37	ns
LVC MOS18, Slow, 8 mA	1.25	1.43	2.37	2.57	2.37	2.57	ns
LVC MOS18, Slow, 12 mA	1.25	1.43	2.13	2.33	2.13	2.33	ns
LVC MOS18, Slow, 16 mA	1.25	1.43	2.13	2.33	2.13	2.33	ns
LVC MOS18, Slow, 24 mA	1.25	1.43	2.13	2.33	2.13	2.33	ns
LVC MOS18, Fast, 2 mA	1.25	1.43	3.78	3.98	3.78	3.98	ns
LVC MOS18, Fast, 4 mA	1.25	1.43	2.54	2.74	2.54	2.74	ns
LVC MOS18, Fast, 6 mA	1.25	1.43	2.02	2.22	2.02	2.22	ns
LVC MOS18, Fast, 8 mA	1.25	1.43	1.95	2.15	1.95	2.15	ns
LVC MOS18, Fast, 12 mA	1.25	1.43	1.85	2.05	1.85	2.05	ns
LVC MOS18, Fast, 16 mA	1.25	1.43	1.85	2.05	1.85	2.05	ns
LVC MOS18, Fast, 24 mA	1.25	1.43	1.85	2.05	1.85	2.05	ns
LVC MOS18_JEDEC, QUIETIO, 2 mA	1.01	1.19	6.09	6.29	6.09	6.29	ns
LVC MOS18_JEDEC, QUIETIO, 4 mA	1.01	1.19	4.89	5.09	4.89	5.09	ns
LVC MOS18_JEDEC, QUIETIO, 6 mA	1.01	1.19	4.20	4.40	4.20	4.40	ns
LVC MOS18_JEDEC, QUIETIO, 8 mA	1.01	1.19	3.87	4.07	3.87	4.07	ns
LVC MOS18_JEDEC, QUIETIO, 12 mA	1.01	1.19	3.49	3.69	3.49	3.69	ns
LVC MOS18_JEDEC, QUIETIO, 16 mA	1.01	1.19	3.34	3.54	3.34	3.54	ns
LVC MOS18_JEDEC, QUIETIO, 24 mA	1.01	1.19	3.17	3.37	3.17	3.37	ns
LVC MOS18_JEDEC, Slow, 2 mA	1.01	1.19	4.79	4.99	4.79	4.99	ns
LVC MOS18_JEDEC, Slow, 4 mA	1.01	1.19	3.84	4.04	3.84	4.04	ns
LVC MOS18_JEDEC, Slow, 6 mA	1.01	1.19	3.18	3.38	3.18	3.38	ns
LVC MOS18_JEDEC, Slow, 8 mA	1.01	1.19	2.37	2.57	2.37	2.57	ns
LVC MOS18_JEDEC, Slow, 12 mA	1.01	1.19	2.13	2.33	2.13	2.33	ns
LVC MOS18_JEDEC, Slow, 16 mA	1.01	1.19	2.13	2.33	2.13	2.33	ns
LVC MOS18_JEDEC, Slow, 24 mA	1.01	1.19	2.13	2.33	2.13	2.33	ns
LVC MOS18_JEDEC, Fast, 2 mA	1.01	1.19	3.75	3.95	3.75	3.95	ns
LVC MOS18_JEDEC, Fast, 4 mA	1.01	1.19	2.54	2.74	2.54	2.74	ns
LVC MOS18_JEDEC, Fast, 6 mA	1.01	1.19	2.02	2.22	2.02	2.22	ns
LVC MOS18_JEDEC, Fast, 8 mA	1.01	1.19	1.94	2.14	1.94	2.14	ns
LVC MOS18_JEDEC, Fast, 12 mA	1.01	1.19	1.86	2.06	1.86	2.06	ns
LVC MOS18_JEDEC, Fast, 16 mA	1.01	1.19	1.86	2.06	1.86	2.06	ns
LVC MOS18_JEDEC, Fast, 24 mA	1.01	1.19	1.86	2.06	1.86	2.06	ns

Table 34: SSO Limit per V<sub>CC0</sub>/GND Pair (Cont'd)

V <sub>CC0</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CC0</sub> /GND Pair					
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324			
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5		
1.5V	LVCMOS15, LVCMOS15_JEDEC	2	Fast	33	40	33	41		
			Slow	57	62	57	56		
			QuietIO	70	67	70	66		
		4	Fast	19	21	19	21		
			Slow	30	30	30	24		
			QuietIO	38	33	38	30		
		6	Fast	14	16	14	16		
			Slow	18	19	18	17		
			QuietIO	27	24	27	21		
		8	Fast	11	13	11	12		
			Slow	16	16	16	14		
			QuietIO	23	20	23	17		
		12	Fast	N/A	5	N/A	4		
			Slow	N/A	8	N/A	5		
			QuietIO	N/A	10	N/A	9		
		16	Fast	N/A	5	N/A	4		
			Slow	N/A	8	N/A	8		
			QuietIO	N/A	10	N/A	9		
		HSTL_I				9	10	9	10
		HSTL_II				N/A	5	N/A	6
HSTL_III				7	9	7	9		
DIFF_HSTL_I				27	30	27	30		
DIFF_HSTL_II				N/A	15	N/A	18		
DIFF_HSTL_III				21	27	21	27		
SSTL_15_II <sup>(3)</sup>				N/A	5	N/A	4		
DIFF_SSTL_15_II <sup>(3)</sup>				N/A	15	N/A	12		

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair (Cont'd)

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
3.3V	LVCMOS33	2	Fast	42	46	42	44
			Slow	50	55	50	49
			QuietIO	60	68	60	60
		4	Fast	21	27	21	25
			Slow	32	37	32	32
			QuietIO	39	42	39	37
		6	Fast	14	19	14	17
			Slow	19	25	19	22
			QuietIO	29	30	29	25
		8	Fast	11	15	11	14
			Slow	15	20	15	18
			QuietIO	25	24	25	20
		12	Fast	1	3	1	1
			Slow	2	5	2	2
			QuietIO	4	9	4	7
		16	Fast	1	2	1	1
			Slow	1	5	1	1
			QuietIO	3	10	3	8
		24	Fast	1	2	1	1
			Slow	2	5	2	1
			QuietIO	7	9	7	7

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair (Cont'd)

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
Various	LVDS_33			16	N/A	16	N/A
	LVDS_25			20	N/A	20	N/A
	BLVDS_25			20	48	20	20
	MINI_LVDS_33			13	N/A	13	N/A
	MINI_LVDS_25			18	N/A	18	N/A
	RSDS_33			12	N/A	12	N/A
	RSDS_25			15	N/A	15	N/A
	TMDS_33			83	N/A	83	N/A
	PPDS_33			12	N/A	12	N/A
	PPDS_25			16	N/A	16	N/A
	DISPLAY_PORT			42	40	42	30
	I2C			47	55	47	42
	SMBUS			44	52	44	40

**Notes:**

1. SSO limits greater than the number of I/O per V<sub>CCO</sub>/GND pair (Table 33) indicate No Limit for the given I/O standard. They are provided in this table to calculate limits when using multiple I/O standards in a bank.
2. Not available (N/A) indicates that the I/O standard is not available in the given bank.
3. When used with the MCB, these signals are exempt from SSO analysis due to the known activity of the MCB switching patterns. SSO performance is validated for all MCB instances. MCB outputs can, in some cases, exceed the SSO limits.

## Input Serializer/Deserializer Switching Characteristics

Table 37: ISERDES2 Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Setup/Hold for Control Lines</b>						
$T_{ISCK\_BITSLIP} / T_{ISCKC\_BITSLIP}$	BITSLIP pin Setup/Hold with respect to CLKDIV	0.16/ -0.09	0.20/ -0.09	0.31/ -0.09	0.34/ -0.14	ns
$T_{ISCK\_CE} / T_{ISCKC\_CE}$	CE pin Setup/Hold with respect to CLK	0.71/ -0.47	0.71/ -0.42	0.97/ -0.42	1.39/ -0.71	ns
<b>Setup/Hold for Data Lines</b>						
$T_{ISDCK\_D} / T_{ISCKD\_D}$	D pin Setup/Hold with respect to CLK	0.24/ -0.15	0.25/ -0.05	0.29/ -0.05	0.09/ -0.05	ns
$T_{ISDCK\_DDLY} / T_{ISCKD\_DDLY}$	DDLY pin Setup/Hold with respect to CLK (using IODELAY2)	-0.25/ 0.30	-0.25/ 0.42	-0.25/ 0.56	-0.54/ 0.67	ns
$T_{ISDCK\_D\_DDR} / T_{ISCKD\_D\_DDR}$	D pin Setup/Hold with respect to CLK at DDR mode	-0.03/ 0.04	-0.03/ 0.16	-0.03/ 0.18	-0.05/ 0.12	ns
$T_{ISDCK\_DDLY\_DDR} / T_{ISCKD\_DDLY\_DDR}$	D pin Setup/Hold with respect to CLK at DDR mode (using IODELAY2)	-0.40/ 0.48	-0.40/ 0.53	-0.40/ 0.71	-0.71/ 0.86	ns
<b>Sequential Delays</b>						
$T_{ISCKO\_Q}$	CLKDIV to out at Q pin	1.30	1.44	2.02	2.22	ns
$F_{CLKDIV}$	CLKDIV maximum frequency	270	262.5	250	125	MHz

## Output Serializer/Deserializer Switching Characteristics

Table 38: OSERDES2 Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Setup/Hold</b>						
$T_{OSDCK\_D} / T_{OSCKD\_D}$	D input Setup/Hold with respect to CLKDIV	-0.03/ 1.02	-0.03/ 1.17	-0.03/ 1.27	-0.02/ 0.23	ns
$T_{OSDCK\_T} / T_{OSCKD\_T}^{(1)}$	T input Setup/Hold with respect to CLK	-0.05/ 1.03	-0.05/ 1.13	-0.05/ 1.23	-0.05/ 0.24	ns
$T_{OSCCK\_OCE} / T_{OSCKC\_OCE}$	OCE input Setup/Hold with respect to CLK	0.12/ -0.03	0.15/ -0.03	0.24/ -0.03	0.28/ -0.17	ns
$T_{OSCCK\_TCE} / T_{OSCKC\_TCE}$	TCE input Setup/Hold with respect to CLK	0.14/ -0.08	0.17/ -0.08	0.27/ -0.08	0.31/ -0.16	ns
<b>Sequential Delays</b>						
$T_{OSCKO\_OQ}$	Clock to out from CLK to OQ	0.94	1.11	1.51	1.89	ns
$T_{OSCKO\_TQ}$	Clock to out from CLK to TQ	0.94	1.11	1.51	1.91	ns
$F_{CLKDIV}$	CLKDIV maximum frequency	270	262.5	250	125	MHz

**Notes:**

- $T_{OSDCK\_T2} / T_{OSCKD\_T2}$  (T input setup/hold with respect to CLKDIV) are reported as  $T_{OSDCK\_T} / T_{OSCKD\_T}$  in TRACE report.

## DSP48A1 Switching Characteristics

Table 44: DSP48A1 Switching Characteristics

Symbol	Description	Pre-adder	Multiplier	Post-adder	Speed Grade				Units
					-3	-3N	-2	-1L	
<b>Setup and Hold Times of Data/Control Pins to the Input Register Clock</b>									
$T_{DSPDCK\_A\_A1REG}/$ $T_{DSPCKD\_A\_A1REG}$	A input to A1 register CLK	N/A	N/A	N/A	0.15/ 0.09	0.17/ 0.09	0.17/ 0.09	0.32/ 0.09	ns
$T_{DSPDCK\_D\_B1REG}/$ $T_{DSPCKD\_D\_B1REG}$	D input to B1 register CLK	Yes	N/A	N/A	1.90/ -0.07	1.95/ -0.07	1.95/ -0.07	2.82/ -0.07	ns
$T_{DSPDCK\_C\_CREG}/$ $T_{DSPCKD\_C\_CREG}$	C input to C register CLK for XC devices	N/A	N/A	N/A	0.11/ 0.15	0.13/ 0.15	0.13/ 0.15	0.24/ 0.09	ns
	C input to C register CLK for XA and XQ devices				0.11/ 0.19	N/A	0.13/ 0.23	0.24/ 0.09	
$T_{DSPDCK\_D\_DREG}/$ $T_{DSPCKD\_D\_DREG}$	D input to D register CLK for XC devices	N/A	N/A	N/A	0.09/ 0.15	0.10/ 0.15	0.10/ 0.15	0.19/ 0.12	ns
	D input to D register CLK for XA and XQ devices				0.09/ 0.23	N/A	0.10/ 0.27	0.19/ 0.12	
$T_{DSPDCK\_OPMODE\_B1REG}/$ $T_{DSPCKD\_OPMODE\_B1REG}$	OPMODE input to B1 register CLK	Yes	N/A	N/A	1.97/ 0.01	2.00/ 0.01	2.00/ 0.01	2.85/ 0.01	ns
$T_{DSPDCK\_OPMODE\_OPMODEREG}/$ $T_{DSPCKD\_OPMODE\_OPMODEREG}$	OPMODE input to OPMODE register CLK for XC devices	N/A	N/A	N/A	0.18/ 0.12	0.21/ 0.12	0.21/ 0.12	0.40/ 0.12	ns
	OPMODE input to OPMODE register CLK for XA and XQ devices				0.18/ 0.16	N/A	0.21/ 0.22	0.40/ 0.12	
<b>Setup and Hold Times of Data Pins to the Pipeline Register Clock</b>									
$T_{DSPDCK\_A\_MREG}/$ $T_{DSPCKD\_A\_MREG}$	A input to M register CLK	N/A	Yes	N/A	3.06/ -0.40	3.51/ -0.40	3.51/ -0.40	3.97/ -0.40	ns
$T_{DSPDCK\_B\_MREG}/$ $T_{DSPCKD\_B\_MREG}$	B input to M register CLK	Yes	Yes	N/A	3.96/ -0.68	4.58/ -0.68	4.58/ -0.68	7.00/ -0.68	ns
$T_{DSPDCK\_D\_MREG}/$ $T_{DSPCKD\_D\_MREG}$	D input to M register CLK	Yes	Yes	N/A	4.23/ -0.56	4.80/ -0.56	4.80/ -0.56	6.84/ -0.56	ns
$T_{DSPDCK\_OPMODE\_MREG}/$ $T_{DSPCKD\_OPMODE\_MREG}$	OPMODE to M register CLK	Yes	Yes	N/A	4.18/ -0.48	4.80/ -0.48	4.80/ -0.48	6.88/ -0.48	ns
		No	Yes	N/A	2.37/ -0.48	2.70/ -0.48	2.70/ -0.48	4.28/ -0.48	ns
<b>Setup and Hold Times of Data/Control Pins to the Output Register Clock</b>									
$T_{DSPDCK\_A\_PREG}/$ $T_{DSPCKD\_A\_PREG}$	A input to P register CLK	N/A	Yes	Yes	4.32/ -0.76	5.06/ -0.76	5.06/ -0.76	7.52/ -0.76	ns
$T_{DSPDCK\_B\_PREG}/$ $T_{DSPCKD\_B\_PREG}$	B input to P register CLK	Yes	Yes	Yes	5.87/ -0.59	6.87/ -0.59	6.87/ -0.59	10.55/ -0.59	ns
		No	Yes	Yes	4.14/ -0.93	4.68/ -0.93	4.68/ -0.93	8.12/ -0.93	ns
$T_{DSPDCK\_C\_PREG}/$ $T_{DSPCKD\_C\_PREG}$	C input to P register CLK	N/A	N/A	Yes	2.20/ -0.23	2.25/ -0.23	2.25/ -0.23	3.27/ -0.23	ns
$T_{DSPDCK\_D\_PREG}/$ $T_{DSPCKD\_D\_PREG}$	D input to P register CLK	Yes	Yes	Yes	5.90/ -0.92	6.91/ -0.92	6.91/ -0.92	10.39/ -0.92	ns

## Configuration Switching Characteristics

Table 47: Configuration Switching Characteristics<sup>(1)</sup>

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Power-up Timing Characteristics</b>						
T <sub>PL</sub> <sup>(2)</sup>	PROGRAM_B Latency	4	4	4	5	ms, Max
T <sub>POR</sub> <sup>(2)</sup>	Power-on reset (50 ms ramp time) <sup>(3)</sup>	5/30	5/34	5/40	5/40	ms, Min/Max
	Power-on reset (10 ms ramp time)	5/25	5/29	5/35	5/40	ms, Min/Max
T <sub>PROGRAM</sub>	PROGRAM_B Pulse Width	500	500	500	500	ns, Min
<b>Slave Serial Mode Programming Switching</b>						
T <sub>DCCK</sub> /T <sub>CCKD</sub>	DIN Setup/Hold, slave mode	6.0/1.0	6.0/1.0	6.0/1.0	8.0/2.0	ns, Min
T <sub>CCO</sub>	CCLK to DOUT	12	12	12	17	ns, Max
F <sub>SCCK</sub>	Slave mode external CCLK	80	80	80	50	MHz, Max
<b>Slave SelectMAP Mode Programming Switching</b>						
T <sub>SMDCCK</sub> /T <sub>SMCCKD</sub>	SelectMAP Data Setup/Hold	6.0/1.0	6.0/1.0	6.0/1.0	8.0/2.0	ns, Min
T <sub>SMCSCCK</sub> /T <sub>SMCCKCS</sub>	CSI_B Setup/Hold	7.0/0.0	7.0/0.0	7.0/0.0	9.0/2.0	ns, Min
T <sub>SMWCCK</sub> /T <sub>SMCCKW</sub>	RDWR_B Setup/Hold	17.0/1.0	17.0/1.0	17.0/1.0	27.0/2.0	ns, Min
T <sub>SMCKCSO</sub>	CSO_B clock to out	16	16	16	26	ns, Max
T <sub>SMCO</sub>	CCLK to DATA out in readback	13	13	13	25	ns, Max
T <sub>SMCKBY</sub>	CCLK to BUSY out in readback	12	12	12	17	ns, Max
F <sub>SMCCK</sub>	Maximum CCLK frequency (LX4, LX9, LX16, LX25, LX25T, LX45, LX45T, LX75, and LX75T only)	50	50	50	25	MHz, Max
	Maximum CCLK frequency (LX100 and LX100T in x8 mode, LX150, and LX150T only)	40	40	40	20	MHz, Max
	Maximum CCLK frequency (LX100 and LX100T in x16 mode only)	35	35	35	20	MHz, Max
F <sub>RBCK</sub>	Maximum Readback CCLK frequency, including block RAM (LX4, LX9, LX16, LX25, LX25T, LX45, LX45T, LX75, and LX75T only)	20	20	20	4	MHz, Max
	Maximum Readback CCLK frequency, ignoring block RAM (POST_CRC) (LX4, LX9, LX16, LX25, LX25T, LX45, LX45T, LX75, and LX75T only)	50	50	50	30	MHz, Max
	Maximum Readback CCLK frequency, including block RAM (LX100, LX100T, LX150, and LX150T only)	12	12	12	4	MHz, Max
	Maximum Readback CCLK frequency, ignoring block RAM (POST_CRC) (LX100, LX100T, LX150, and LX150T only)	35	35	35	20	MHz, Max
<b>Boundary-Scan Port Timing Specifications</b>						
T <sub>TAPTCK</sub>	TMS and TDI Setup time before TCK	10	10	10	17	ns, Min
T <sub>TCKTAP</sub>	TMS and TDI Hold time after TCK	5.5	5.5	5.5	5.5	ns, Min
T <sub>TCKTDO</sub>	TCK falling edge to TDO output valid	6.5	6.5	6.5	8	ns, Max
T <sub>TCKH</sub>	TCK clock minimum High time	12	12	12	21	ns, Min
T <sub>TCKL</sub>	TCK clock minimum Low time	12	12	12	21	ns, Min
F <sub>TCK</sub>	Maximum configuration TCK clock frequency	33	33	33	18	MHz, Max
F <sub>TCKB</sub>	Maximum boundary-scan TCK clock frequency	33	33	33	18	MHz, Max
F <sub>TCKAES</sub>	Maximum AES key TCK clock frequency	2	2	2	2	MHz, Max

## Clock Buffers and Networks

Table 48: Global Clock Switching Characteristics (BUFGMUX)

Symbol	Description	Devices	Speed Grade				Units
			-3	-3N	-2	-1L	
T <sub>GSI</sub>	S pin Setup to I0/I1 inputs	LX devices	0.25	0.31	0.48	0.48	ns
		LXT devices	0.25	0.31	0.48	N/A	ns
T <sub>GIO</sub>	BUFGMUX delay from I0/I1 to O	LX devices	0.21	0.21	0.21	0.21	ns
		LXT devices	0.21	0.21	0.21	N/A	ns
<b>Maximum Frequency</b>							
F <sub>MAX</sub>	Global clock tree (BUFGMUX)	LX devices	400	400	375	250	MHz
		LXT devices	400	400	375	N/A	MHz

Table 49: Input/Output Clock Switching Characteristics (BUFIO2)

Symbol	Description	Devices	Speed Grade				Units
			-3	-3N	-2	-1L	
T <sub>BUFCO_O</sub>	Clock to out delay from I to O	LX devices	0.67	0.82	1.09	1.50	ns
		LXT devices	0.67	0.82	1.09	N/A	ns
<b>Maximum Frequency</b>							
F <sub>MAX</sub>	I/O clock tree (BUFIO2)	LX devices	540	525	500	300	MHz
		LXT devices	540	525	500	N/A	MHz

Table 50: Input/Output Clock Switching Characteristics (BUFIO2FB)

Symbol	Description	Devices	Speed Grade				Units
			-3	-3N	-2	-1L	
<b>Maximum Frequency</b>							
F <sub>MAX</sub>	I/O clock tree (BUFIO2FB)	LX devices	1080	1050	950	500	MHz
		LXT devices	1080	1050	950	N/A	MHz

Table 51: Input/Output Clock Switching Characteristics (BUFPLL)

Symbol	Description	Devices	Speed Grade				Units
			-3	-3N	-2	-1L	
<b>Maximum Frequency</b>							
F <sub>MAX</sub>	BUFPLL clock tree (BUFPLL)	LX devices	1080	1050	950	500	MHz
		LXT devices	1080	1050	950	N/A	MHz

## PLL Switching Characteristics

Table 52: PLL Specification

Symbol	Description	Device <sup>(1)</sup>	Speed Grade				Units
			-3	-3N	-2	-1L	
F <sub>INMAX</sub>	Maximum Input Clock Frequency from I/O Clock	LX devices	540	525	450	300	MHz
		LXT devices	540	525	450	N/A	MHz
	Maximum Input Clock Frequency from Global Clock	LX devices	400	400	375	250	MHz
		LXT devices	400	400	375	N/A	MHz

## Spartan-6 Device Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. The representative values for typical pin locations and normal clock loading are listed in Table 63 through Table 69. Values are expressed in nanoseconds unless otherwise noted.

Table 63: Global Clock Input to Output Delay Without DCM or PLL

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>without</i> DCM or PLL							
T <sub>ICKOF</sub>	Global Clock and OUTFF <i>without</i> DCM or PLL	XC6SLX4	6.12	N/A	7.68	9.41	ns
		XC6SLX9	6.12	6.51	7.68	9.41	ns
		XC6SLX16	5.98	6.42	7.48	9.10	ns
		XC6SLX25	6.20	6.69	7.84	9.44	ns
		XC6SLX25T	6.20	6.69	7.84	N/A	ns
		XC6SLX45	6.37	6.88	8.10	9.61	ns
		XC6SLX45T	6.37	6.88	8.10	N/A	ns
		XC6SLX75	6.39	6.99	8.16	10.18	ns
		XC6SLX75T	6.39	6.99	8.16	N/A	ns
		XC6SLX100	6.59	7.18	8.41	10.31	ns
		XC6SLX100T	6.59	7.18	8.41	N/A	ns
		XC6SLX150	6.98	7.68	8.80	10.62	ns
		XC6SLX150T	6.98	7.68	8.80	N/A	ns
		XA6SLX4	6.44	N/A	7.68	N/A	ns
		XA6SLX9	6.44	N/A	7.68	N/A	ns
		XA6SLX16	6.30	N/A	7.48	N/A	ns
		XA6SLX25	6.52	N/A	7.84	N/A	ns
		XA6SLX25T	6.52	N/A	7.84	N/A	ns
		XA6SLX45	6.69	N/A	8.12	N/A	ns
		XA6SLX45T	6.69	N/A	8.12	N/A	ns
		XA6SLX75	6.89	N/A	8.16	N/A	ns
		XA6SLX75T	6.89	N/A	8.16	N/A	ns
		XA6SLX100	N/A	N/A	8.36	N/A	ns
XQ6SLX75	N/A	N/A	8.16	10.18	ns		
XQ6SLX75T	6.89	N/A	8.16	N/A	ns		
XQ6SLX150	N/A	N/A	8.80	10.62	ns		
XQ6SLX150T	7.61	N/A	8.80	N/A	ns		

**Notes:**

- Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.

Table 64: Global Clock Input to Output Delay With DCM in System-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, with DCM in System-Synchronous Mode.							
T <sub>ICKOFDCM</sub>	Global Clock and OUTFF with DCM	XC6SLX4	4.23	N/A	6.11	6.60	ns
		XC6SLX9	4.23	5.17	6.11	6.60	ns
		XC6SLX16	4.28	4.57	5.34	6.36	ns
		XC6SLX25	3.95	4.18	4.59	6.91	ns
		XC6SLX25T	3.95	4.18	4.59	N/A	ns
		XC6SLX45	4.37	4.70	5.50	6.85	ns
		XC6SLX45T	4.37	4.70	5.50	N/A	ns
		XC6SLX75	3.90	4.23	4.77	6.31	ns
		XC6SLX75T	3.90	4.23	4.77	N/A	ns
		XC6SLX100	3.86	4.16	4.66	7.25	ns
		XC6SLX100T	3.90	4.16	4.66	N/A	ns
		XC6SLX150	4.03	4.33	4.83	6.63	ns
		XC6SLX150T	4.03	4.33	4.83	N/A	ns
		XA6SLX4	4.55	N/A	6.11	N/A	ns
		XA6SLX9	4.55	N/A	6.11	N/A	ns
		XA6SLX16	4.62	N/A	5.33	N/A	ns
		XA6SLX25	4.27	N/A	4.59	N/A	ns
		XA6SLX25T	4.27	N/A	4.69	N/A	ns
		XA6SLX45	4.69	N/A	5.50	N/A	ns
		XA6SLX45T	4.69	N/A	5.50	N/A	ns
		XA6SLX75	4.22	N/A	4.77	N/A	ns
		XA6SLX75T	4.22	N/A	4.77	N/A	ns
		XA6SLX100	N/A	N/A	5.34	N/A	ns
		XQ6SLX75	N/A	N/A	4.77	6.31	ns
		XQ6SLX75T	4.22	N/A	4.77	N/A	ns
		XQ6SLX150	N/A	N/A	4.96	6.63	ns
		XQ6SLX150T	4.62	N/A	4.96	N/A	ns

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM output jitter is already included in the timing calculation.

Table 71: Global Clock Setup and Hold Without DCM or PLL (Default Delay)

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
<b>Input Setup and Hold Time Relative to Global Clock Input Signal for LVC MOS25 Standard.<sup>(1)</sup></b>							
T <sub>PSFD</sub> / T <sub>PHFD</sub>	Default Delay <sup>(2)</sup> Global Clock and IFF <sup>(3)</sup> without DCM or PLL	XC6SLX4	0.66/1.17	N/A	1.05/0.79	2.09/1.05	ns
		XC6SLX9	0.66/1.17	0.75/1.17	1.05/1.17	2.09/1.05	ns
		XC6SLX16	0.87/1.16	0.93/1.16	0.96/1.16	1.86/1.06	ns
		XC6SLX25	0.68/0.77	0.81/0.81	0.87/0.82	2.21/1.33	ns
		XC6SLX25T	0.68/0.77	0.81/0.81	0.87/0.82	N/A	ns
		XC6SLX45	0.40/1.05	0.42/1.17	0.64/1.20	1.61/1.67	ns
		XC6SLX45T	0.40/1.05	0.42/1.17	0.64/1.20	N/A	ns
		XC6SLX75	0.41/1.11	0.41/1.13	0.80/1.14	1.23/1.82	ns
		XC6SLX75T	0.41/1.11	0.41/1.13	0.80/1.14	N/A	ns
		XC6SLX100	0.39/1.12	0.39/1.23	0.39/1.28	1.13/1.94	ns
		XC6SLX100T	0.39/1.12	0.39/1.23	0.39/1.28	N/A	ns
		XC6SLX150	0.23/1.54	0.23/1.62	0.23/1.62	1.14/2.05	ns
		XC6SLX150T	0.23/1.54	0.23/1.62	0.23/1.62	N/A	ns
		XA6SLX4	0.73/1.18	N/A	1.05/0.80	N/A	ns
		XA6SLX9	0.73/1.18	N/A	1.05/0.80	N/A	ns
		XA6SLX16	0.90/1.20	N/A	0.96/0.75	N/A	ns
		XA6SLX25	0.70/0.81	N/A	0.87/0.91	N/A	ns
		XA6SLX25T	0.76/0.81	N/A	1.03/0.91	N/A	ns
		XA6SLX45	0.40/1.06	N/A	0.64/1.20	N/A	ns
		XA6SLX45T	0.40/1.06	N/A	0.64/1.20	N/A	ns
		XA6SLX75	0.41/1.24	N/A	0.80/1.18	N/A	ns
		XA6SLX75T	0.41/1.24	N/A	0.80/1.18	N/A	ns
		XA6SLX100	N/A	N/A	0.86/1.55	N/A	ns
		XQ6SLX75	N/A	N/A	0.80/1.18	1.23/1.82	ns
		XQ6SLX75T	0.41/1.24	N/A	0.80/1.18	N/A	ns
		XQ6SLX150	N/A	N/A	0.28/1.57	1.14/2.05	ns
XQ6SLX150T	0.28/1.78	N/A	0.28/1.57	N/A	ns		

**Notes:**

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage.
2. Default delay uses IODELAY2 tap 0.
3. IFF = Input Flip-Flop or Latch.

## Revision History

The following table shows the revision history for this document.

Date	Version	Description of Revisions
06/24/09	1.0	Initial Xilinx release.
08/26/09	1.1	Added $V_{FS}$ to <a href="#">Table 1</a> and <a href="#">Table 2</a> . Added $R_{FUSE}$ to <a href="#">Table 2</a> . Added XC6SLX75 and XC6SLX75T to $V_{BATT}$ and $I_{BATT}$ in <a href="#">Table 1</a> , <a href="#">Table 2</a> , and <a href="#">Table 4</a> . Corrected the quiescent supply current for the XC6SLX4 in <a href="#">Table 5</a> . Updated <a href="#">Table 11</a> . Removed $DV_{PPIN}$ from <a href="#">Figure 2</a> . Removed $F_{PCIECORE}$ from <a href="#">Table 24</a> and added values to $F_{PCIEUSER}$ . Added more networking applications to <a href="#">Table 25</a> . Updated values for $T_{SUSPENDLOW\_AWAKE}$ , $T_{SUSPEND\_ENABLE}$ , and $T_{SCP\_AWAKE}$ in <a href="#">Table 46</a> . Numerous changes to <a href="#">Table 47</a> , <a href="#">page 54</a> including the addition of new values to various specifications, revising the $T_{SMCKCSO}$ description, and changing the units of $T_{POR}$ . Also, removed <i>Dynamic Reconfiguration Port (DRP) for DCM and PLL Before and After DCLK section</i> from <a href="#">Table 47</a> and updated all the notes. In <a href="#">Table 52</a> , added to $F_{INMAX}$ , revised $F_{OUTMAX}$ , and removed PLL Maximum Output Frequency for BUFIO2. Revised values for DCM_DELAY_STEP in <a href="#">Table 54</a> . Updated CLKIN_FREQ_FX values in <a href="#">Table 55</a> .
01/04/10	1.2	Added -4 speed grade to entire document. Updated speed specification of -4, -3, -2 speed grades to version 1.03. Added -1L speed grade numbers per speed specification 1.00. Updated $T_{SOL}$ in <a href="#">Table 1</a> . Added -1L rows for LVCMOS12, LVCMOS15, and LVCMOS18 in <a href="#">Table 9</a> . Revised much of the detail in <a href="#">GTP Transceiver Specifications</a> in <a href="#">Table 12</a> through <a href="#">Table 23</a> . Added -2 data to <a href="#">Table 25</a> . Updated $F_{MAX}$ in <a href="#">Table 44</a> . Updated descriptions for $T_{DNACLKL}$ and $T_{DNACLKH}$ in <a href="#">Table 45</a> and revised values for all parameters. Removed $T_{INITADDR}$ from <a href="#">Table 47</a> and added new data. Updated values in <a href="#">Table 48</a> through <a href="#">Table 62</a> . Added <a href="#">Table 51</a> (BUFPLL) and <a href="#">Table 57</a> (DCM_CLKGEN). Removed $T_{LOCKMAX}$ note from <a href="#">Table 52</a> . Updated note 3 in <a href="#">Table 53</a> . In <a href="#">Table 79</a> : removed XC6SLX75CSG324 and XC6SLX75TCSG324; added XC6SLX75FG(G)484 and XC6SLX75FG(G)484.
02/22/10	1.3	Production release of XC6SLX16 -2 speed grade devices. The changes to <a href="#">Table 26</a> and <a href="#">Table 27</a> includes updating this data sheet to the data in ISE v11.5 software with speed specification v1.06. Updated maximum of $V_{IN}$ and $V_{TS}$ and note 2 in <a href="#">Table 1</a> . In <a href="#">Table 2</a> , changed $V_{IN}$ , added $I_{IN}$ and note 5, revised notes 1, 6, and 7, and added note 8 to $R_{FUSE}$ . In <a href="#">Table 4</a> , removed previous note 1 and added data to $I_{RPU}$ , $I_{RPD}$ , and $I_{BATT}$ , changed $C_{IN}$ , added $R_{DT}$ and $R_{IN\_TERM}$ , and added note 2 and 3. Updated $V_{CCO2}$ in <a href="#">Table 6</a> . Added <a href="#">Table 7</a> and <a href="#">Table 8</a> . Removed PCI66_3 from <a href="#">Table 9</a> . Updated PCI33_3 and I2C in <a href="#">Table 9</a> . Updated the description of <a href="#">Table 11</a> . Completely updated <a href="#">Table 25</a> . Updated <a href="#">Table 28</a> including adding values for PCI33_3. Updated $V_{REF}$ value for HSTL_III_18 in <a href="#">Table 31</a> . Updates missing $V_{REF}$ values in <a href="#">Table 32</a> . Added <a href="#">Simultaneously Switching Outputs</a> , <a href="#">page 36</a> . Removed $T_{GSRQ}$ and $T_{RPW}$ from <a href="#">Table 35</a> and <a href="#">Table 36</a> . Also removed $T_{DOQ}$ from <a href="#">Table 36</a> . Removed $T_{ISDO\_DO}$ and note 1 from <a href="#">Table 37</a> . Removed $T_{OSCK\_S}$ and combinatorial section from <a href="#">Table 38</a> . In <a href="#">Table 39</a> , removed $T_{IODDO\_T}$ and added new tap parameters and note 2. In <a href="#">Table 40</a> , <a href="#">Table 41</a> , and <a href="#">Table 42</a> , made typographical edits and removed notes. Removed clock CLK section in <a href="#">Table 41</a> . Removed clock CLK section and $T_{REG\_MUX}$ and $T_{REG\_M31}$ in <a href="#">Table 42</a> . Added block RAM $F_{MAX}$ values to <a href="#">Table 43</a> . Updated values and added note 2 to <a href="#">Table 45</a> . Added values to <a href="#">Table 46</a> and removed note 1. Numerous changes to <a href="#">Table 47</a> . Completely updated <a href="#">Table 57</a> . Revised data in <a href="#">Table 62</a> . Removed note 3 from <a href="#">Table 71</a> . Added values to <a href="#">Table 79</a> . Added data to <a href="#">Table 80</a> and <a href="#">Table 81</a> .
03/10/10	1.4	Production release of XC6SLX45 -2 speed grade devices, which includes changes to <a href="#">Table 26</a> and <a href="#">Table 27</a> updating this data sheet to the data in ISE v11.5 software with speed specification v1.07. Fixed $R_{IN\_TERM}$ description in <a href="#">Table 4</a> . Added PCI66_3 to <a href="#">Table 7</a> and replaced note 1. Corrected note 1 and the V, Max for TMDS_33 in <a href="#">Table 8</a> . In <a href="#">Table 10</a> , added note 1 to LVPECL_33 and TMDS_33. Also updated specifications for TMDS_33. Updated the <a href="#">GTP Transceiver Specifications</a> section including adding values to <a href="#">Table 16</a> , <a href="#">Table 17</a> , and <a href="#">Table 20</a> through <a href="#">Table 23</a> . Added PCI66_3 back into <a href="#">Table 9</a> , <a href="#">Table 28</a> , <a href="#">Table 31</a> , <a href="#">Table 32</a> , and <a href="#">Table 34</a> . Updated note 3 on <a href="#">Table 32</a> . In <a href="#">Table 34</a> , corrected some typographical errors and fixed SSO limits for bank1/3 in FG(G)484 package. Corrected $T_{OSCKC\_OCE}$ in <a href="#">Table 38</a> . In <a href="#">Table 57</a> , updated CLKFX_FREEZE_VAR and CLKFX_FREEZE_TEMP_SLOPE and added typical values to $T_{CENTER\_LOW\_SPREAD}$ and $T_{CENTER\_HIGH\_SPREAD}$ . Updated and added values to <a href="#">Table 63</a> through <a href="#">Table 78</a> , and <a href="#">Table 81</a> . In <a href="#">Table 79</a> , revised the XC6SLX16-CSG324 and the XC6SLX45-CSG484 and FG(G)484 values.

Date	Version	Description of Revisions
01/10/11	1.11	<p>Production release of XC6SLX4 and XC6SLX9 in the specific speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v12.4 software with speed specification v1.15 for the -4, -3, -3N, and -2 speed grades. Added note 3 to <a href="#">Table 27</a>. Also updated the -1L speed grade requirements to ISE v12.4 software with speed specification v1.06. Revised -3N definition throughout the document.</p> <p>Added note 4 to <a href="#">Table 2</a> and updated note 5. Added information on <math>V_{CCINT}</math> to note 1 in <a href="#">Table 5</a>. Updated Networking Applications -3 values in <a href="#">Table 25</a> to match improvements made in ISE v12.4. In <a href="#">Table 28</a>, added note 1 and revised the <math>T_{IOTP}</math> values for LVDS_33, LVDS_25, MINI_LVDS_33, MINI_LVDS_25, RSDS_33, RSDS_25, TMDS_33, PPDS_33, and PPDS_25. Added note 3 to <a href="#">Table 55</a>.</p>
02/11/11	1.12	<p>As described in <a href="#">XCN11008: Product Discontinuation Notice For Spartan-6 LXT -4 Devices</a>, the -4 speed specifications have been discontinued. As outlined in page 2 of the XCN, designers currently using -4 speed specifications should rerun timing analysis using the new -3 speed specifications before moving to a replacement device.</p> <p>Updated the networking applications section of <a href="#">Table 25</a>. Updated -2 speed specifications throughout document and added note 3 to <a href="#">Table 27</a> advising designers to use the -2 speed specification update (v1.17) with the ISE 12.4 software patch. Added <math>F_{CLKDIV}</math> to <a href="#">Table 37</a> and <a href="#">Table 38</a>. Updated note 2 in <a href="#">Table 39</a>. Updated units for <math>T_{SMCKCSO}</math> and <math>T_{BPICCO}</math> in <a href="#">Table 47</a>. Updated -1L in <a href="#">Table 71</a>. Removed Note 2: <i>Package delay information is available for these device/package combinations. This information can be used to deskew the package</i> from <a href="#">Table 79</a>.</p>
03/31/11	2.0	<p>Production release of XC6SLX45 in the -1L speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.1 software with -1L speed specification v1.06.</p> <p>In <a href="#">Table 39</a>, removed values in the -1L column and added note 3 as IODELAY2 only supports Tap0 for lower-power devices. Updated copyright <a href="#">page 1</a> and <a href="#">Notice of Disclaimer</a>.</p>
05/20/11	2.1	<p>Production release of XC6SLX100 and XC6SLX150 in the specific speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.1 software with -1L speed specification v1.06. Updated <a href="#">Table 27</a> and <a href="#">Note 7</a> with changes per <a href="#">XCN11012: Speed File Change for -3N Devices</a>. Revised <a href="#">Switching Characteristics</a> section for speed specifications: v1.18 for -3, -3N, and -2; including improvements in <a href="#">Table 73</a> through <a href="#">Table 77</a> and <a href="#">Table 81</a>.</p> <p>Removed <i>Memory Controller Block</i> from the performance heading in <a href="#">Table 2</a> and revised <a href="#">Note 2</a>. In <a href="#">Table 4</a>, added <a href="#">Note 1</a> to <math>C_{IN}</math> and updated the description of <math>R_{IN\_TERM}</math>. Updated <a href="#">Note 1</a> in <a href="#">Table 5</a>. Updated <a href="#">Note 1</a> of <a href="#">Table 7</a>. In <a href="#">Table 25</a>, added and removed -1L specifications, increased the standard performance DDR3 specifications, removed the extended performance DDR3 row and updated <a href="#">Note 3</a> and <a href="#">Note 4</a>. Clarified the introductory information for <a href="#">Table 28</a> and <a href="#">Table 30</a>.</p> <p>In <a href="#">Table 32</a>: Revised <math>V_{MEAS}</math> value for LVCMOS12; revised <math>V_{REF}</math> for LVDS_25, LVDS_33, BLVDS_25, MINI_LVDS_25, MINI_LVDS_33, RSDS_25, and RSDS_33; revised <math>R_{REF}</math> for BLVDS_25 and TMDS_33; and added <a href="#">Note 4</a> and <a href="#">Note 5</a>. Updated <a href="#">Note 2</a> and <a href="#">Note 3</a> in <a href="#">Table 39</a>.</p> <p>In <a href="#">Table 47</a>, revised the values and description of <math>T_{POR}</math> including adding <a href="#">Note 3</a>. Also in <a href="#">Table 47</a>, augmented the description and added specifications for <math>F_{RBCK}</math> and removed XC6SLX4 from <math>F_{MCCK}</math> (maximum frequency, parallel mode (Master Select/MAPI/BPI)). Added BUFGMUX to <a href="#">Table 48</a> title. Added <a href="#">Table 50</a>.</p> <p>In <a href="#">Table 52</a>, revised specifications for <math>T_{EXTFVAR}</math> and <math>F_{INJITTER}</math>. In <a href="#">Table 54</a> removed the 5 MHz &lt; <math>CLKIN\_FREQ\_DLL</math> parameter in the LOCK_DLL description. In both <a href="#">Table 56</a> and <a href="#">Table 57</a>, removed the 5 MHz &lt; <math>F_{CLKIN}</math> parameter in the LOCK_FX description. In <a href="#">Table 58</a>, updated description for PSCLK_FREQ and PSCLK_PULSE.</p> <p>Revised title and symbol of <a href="#">Table 70</a>, added new speed specifications for -1L, and added <a href="#">Note 2</a>. Added <a href="#">Table 71</a>.</p>
07/11/11	2.2	<p>Added the Automotive XA Spartan-6 and Defense-grade Spartan-6Q devices to all appropriate tables while sometimes removing the XC6S nomenclature. Added expanded temperature range (Q) to all appropriate tables. Updated <math>T_{SOL}</math> packages in <a href="#">Table 1</a>. Added <math>R_{OUT\_TERM}</math> to <a href="#">Table 4</a>. Updated <a href="#">Note 2</a> on <a href="#">Table 13</a>.</p> <p>Production release of the XC6SLX4, XC6SLX9, XC6SLX16, XC6SLX25, XC6SLX75, XQ6SLX75, and XQ6SLX150 in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.2 software with -1L speed specification v1.07.</p> <p>Production release of the XA6SLX16, XA6SLX25T, XA6SLX45, XA6SLX45T, XQ6SLX75, XQ6SLX75T, XQ6SLX150, and XQ6SLX150T in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.2 software with -2 and -3 speed specification v1.19.</p> <p>Added <a href="#">Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices(1)</a>. Updated CS(G)484 from CSG484 throughout data sheet. Clarified <a href="#">Note 3</a> in <a href="#">Table 39</a>.</p>
08/08/11	2.3	<p>Production release of the XA6SLX25, XA6SLX75, and XA6SLX75T in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.2 software with -2 and -3 speed specification v1.19.</p>